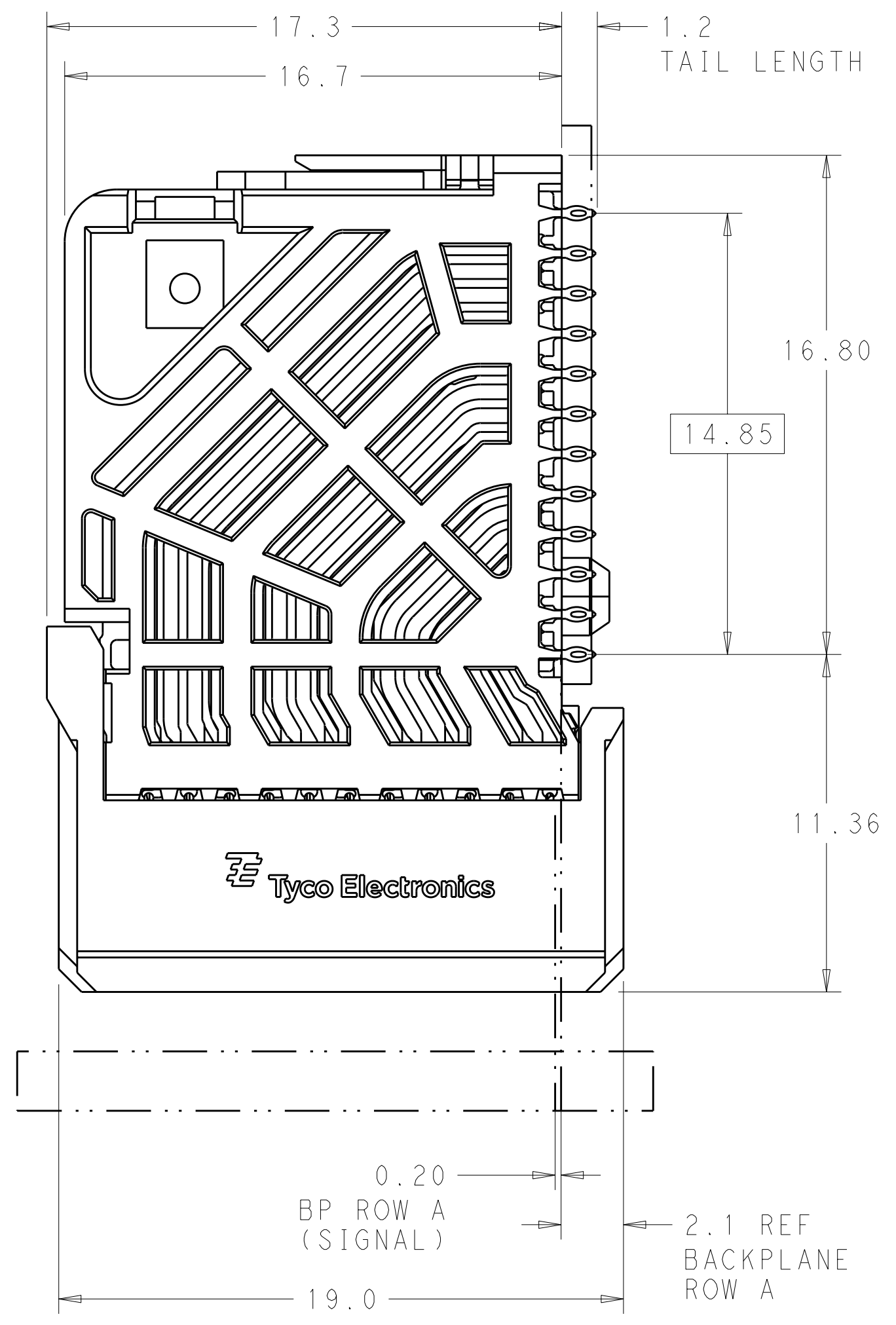
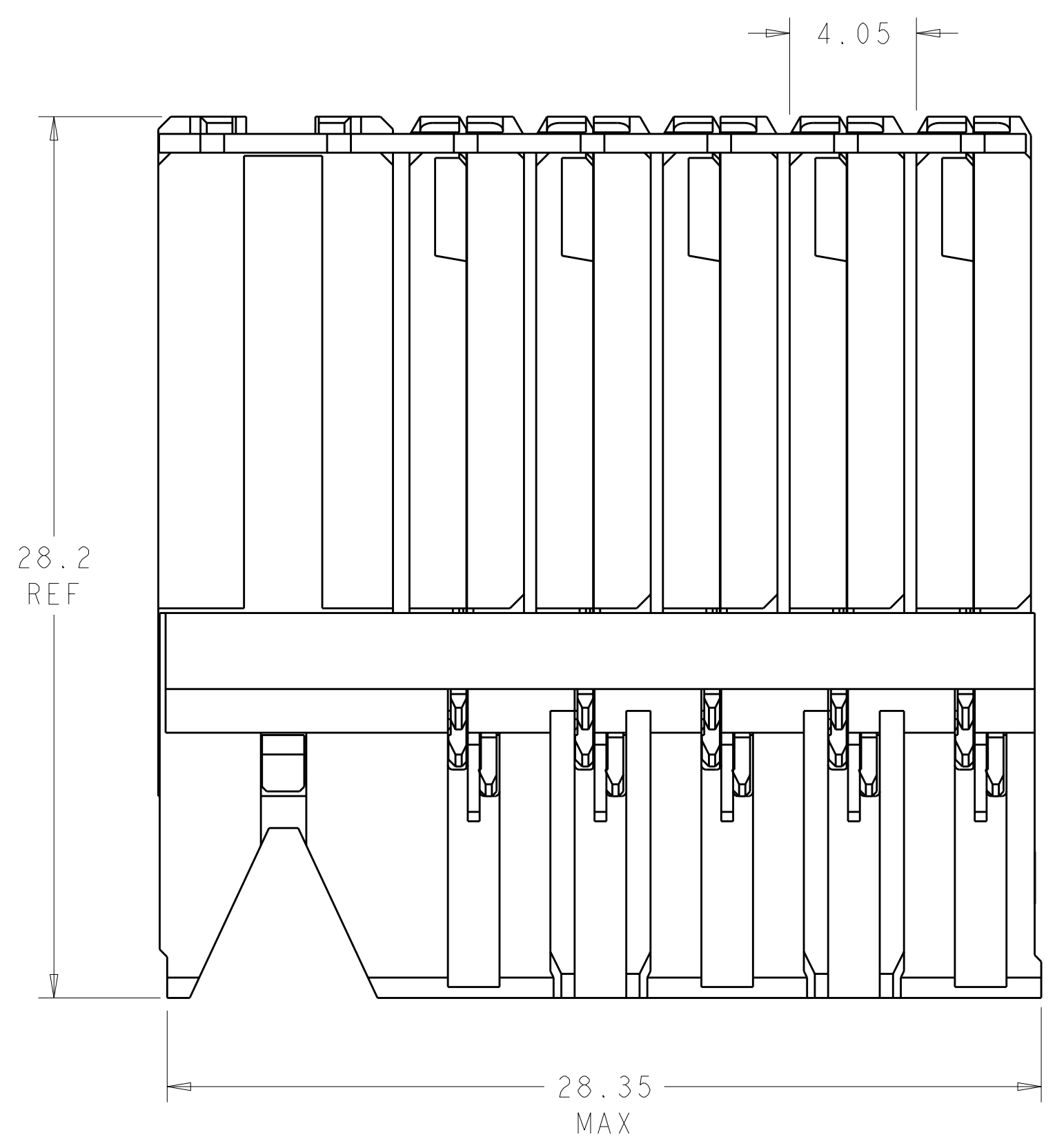
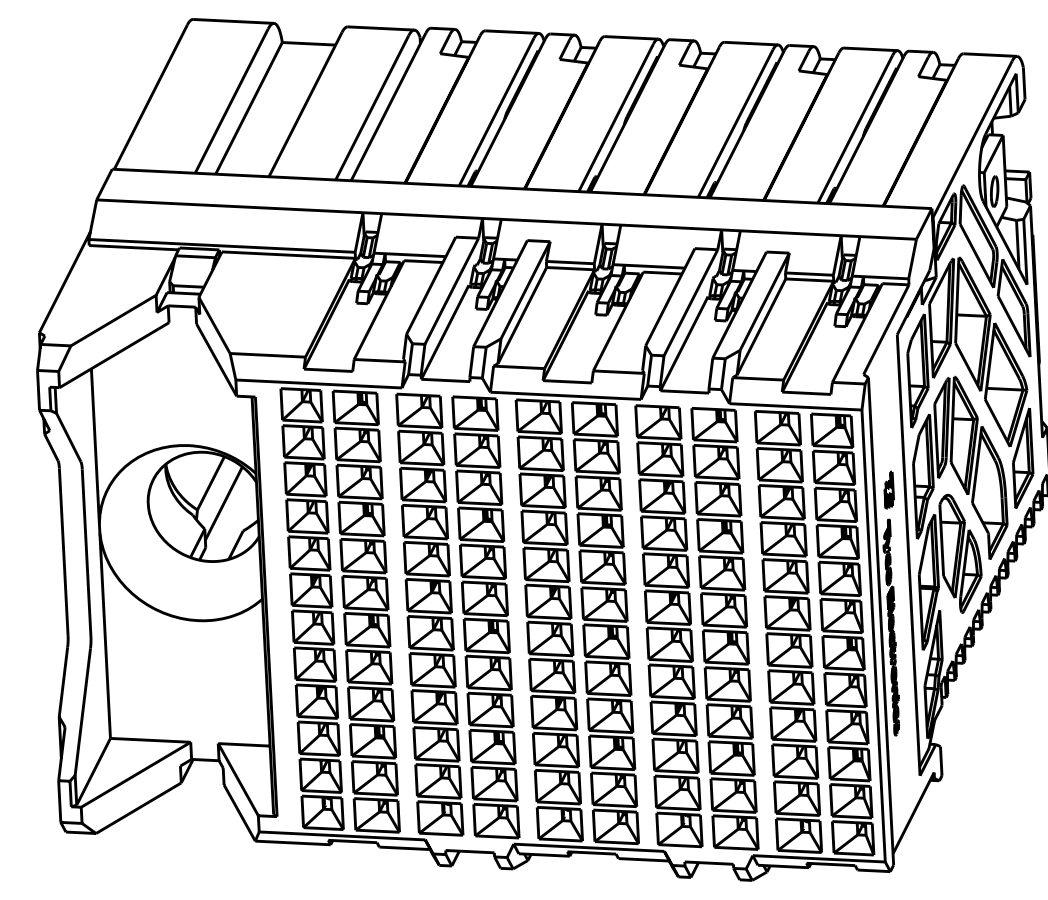


LOC	DIST	REV	DATE	BY	APPD
AD	00	B	18JAN2012	KH	DD

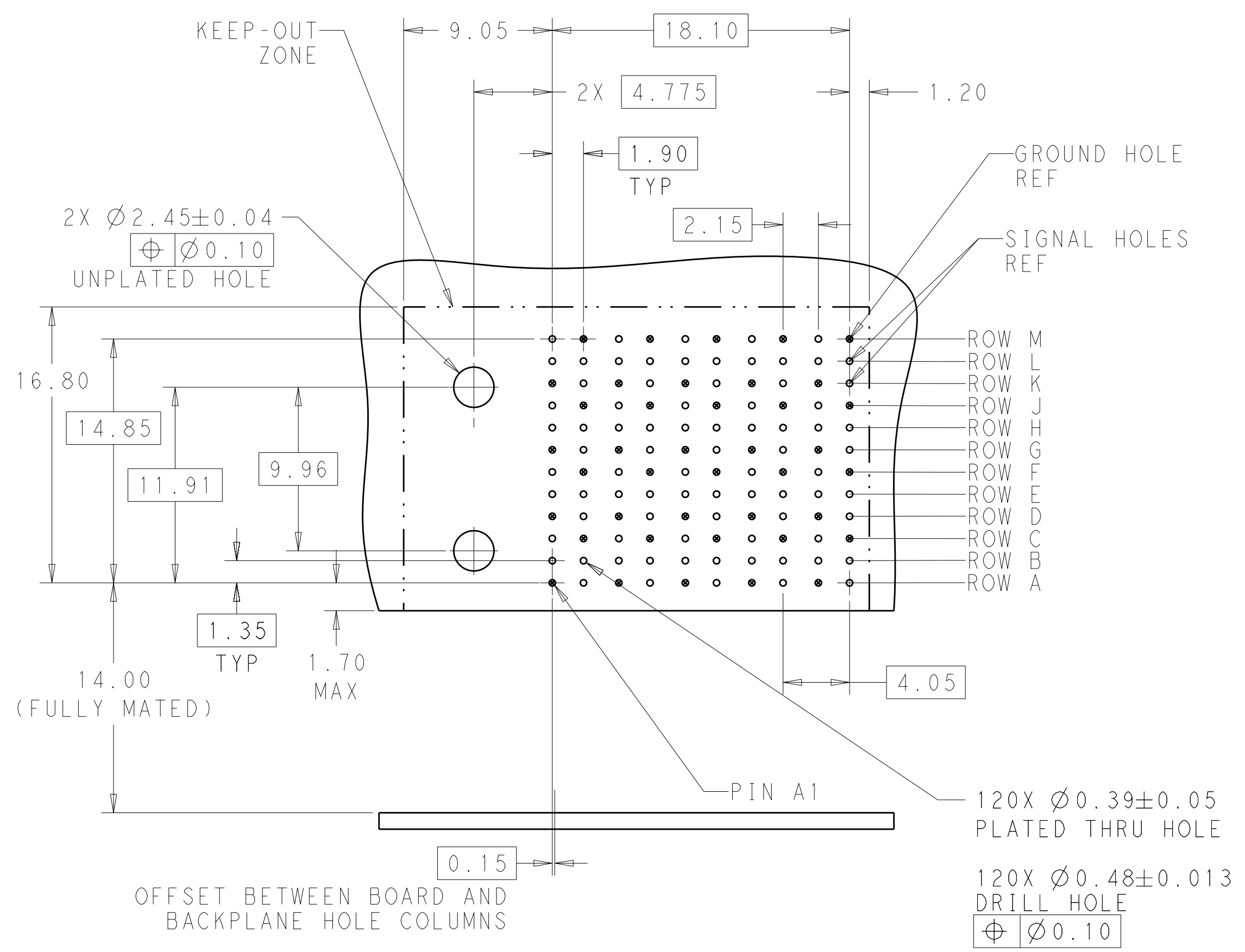
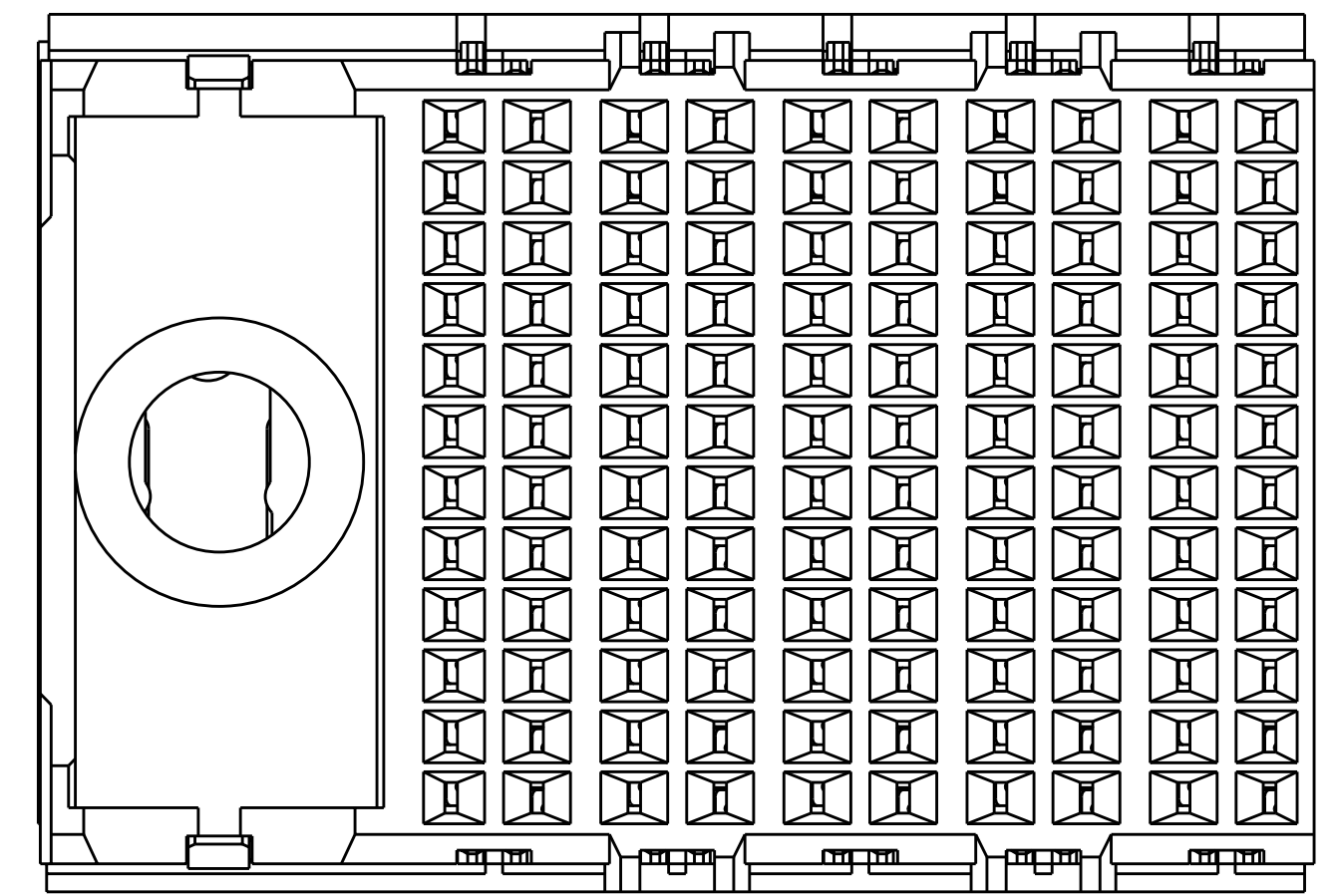


- 1 MATERIAL:
HOUSING: LCP, GLASS FILLED, UL94V-0.
TERMINALS: HIGH PERFORMANCE COPPER ALLOY.
- 2 FINISH:
30µ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN ON PCB TAILS, NICKEL OVERALL.
- 3 FINISH:
30µ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN-LEAD ON PCB TAILS, NICKEL OVERALL.
- 4. CONNECTORS SUPPLIED WITH MOUNTING SCREWS.



SCALE 4:1

REFER TO WWW.TE.COM FOR PRODUCT AVAILABILITY



RECOMMENDED PCB LAYOUT
 MIN BOARD THICKNESS 1.0

KEY POSITION	FINISH	PART NUMBER
NONE	3	2132467-5
NONE	2	2132467-1

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN 22JUN2011	TE Connectivity
DIMENSIONS: mm		CHK D. DIXON 22JUN2011	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD D. DIXON 22JUN2011	NAME: IMPACT, ORTHOGONAL, 4 PAIR, DAUGHTERCARD, 10 COLUMN, LEFT GUIDED, SIGNAL MODULE, 0.39 EYELET
9 PLC ± 1 PLC ±0.25 3 PLC ±0.15 5 PLC ± 4 PLC ± ANGLES ± FINISH SEE TABLE		PRODUCT SPEC APPLICATION SPEC WEIGHT CUSTOMER DRAWING	
MATERIAL		SCALE 6:1	RESTRICTED TO
		SHEET 1 OF 1	REV B